

ABSTRACT

INSPECTING METHOD FOR INSPECTING INFLUENCE OF INSTALLATION ENVIRONMENT UPON PROCESSING APPARATUS

Disclosed herein is an inspecting method for inspecting the influence of an installation environment upon a processing apparatus. The inspecting method includes a mark setting step of setting a mark for specifying a relative positional relation between a chuck table and a processing unit, an imaging step of imaging the mark plural times by using an imaging unit in the condition where a moving unit is at rest, and a determining step of detecting the position of the mark from an image obtained by the imaging step and then determining whether or not the influence of the installation environment upon the processing apparatus is present. The determining step is performed in such a manner that when the amount of change in position of the mark is less than a threshold, it is determined that the relative positional relation between the chuck table and the processing unit is not influenced by the installation environment, whereas when the amount of change in position of the mark is greater than or equal to the threshold, it is determined that the relative positional relation between the chuck table and the processing unit is influenced by the installation environment.

(Figure 4B)